# Patterning Magnetic Recording Media by Deposition on Imprinted, Etched, Pillars

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### **Conventional Granular Recording Media**



- As the bit size is reduced, it includes fewer grains, more noise.
- If the grains are made smaller they come thermally unstable

### Patterned Media



• Prepattern the location of magnetically isolated bits

8 nm

- Isolated media smaller than about 100 nm forms single magnetic domains (exchange dominates magnetostatic interaction)
- Isolated bits down to <10 nm dia. can be stable

## Patterned vs. Unpatterned Media



#### Contact Lithography Methods



Imprint for microelectronic Lithography

- +Intrinsic Resolution < 1nm
- +No resist development process to degrade resolution
- +3D patterning



+Alignment is made easier by contact

(contact distortion not problem)

#### -A 1:1 technique

e-beam mastering unlikely below 20 nm

EUV to make stampers?

! Much needs to be done on defects and alignment

#### Imprinting for Patterning Magnetic Media

- (Chou et al., 1998.)
- High Resolution Required: In 2006, 500 Gbit/in<sup>2</sup>
  - •20 nm bits on 40 nm period, on circular tracks
  - extendable
- •Low patterning cost: <= \$1/disk</pre>
- •But:
  - •Only a single litho level required
  - Long range distortion > 1mm accommodated by head actuator
  - •Defects (up to  $10^{-3}$ ) handled by error correction

### **Magnetic Patterning Methods**

- Patterning the magnetic film
  - additive lift off
  - subtractive etching/milling
- Patterning the magnetics (by ions)
  - Poisoning by implantation
  - Disorder
- Patterning the substrate
  - Pattern holes and fill (Chou)
  - <u>Pattern pillars (imprinting)</u>

#### Substrate Patterning for Magnetic Isolation



- Because lithography is completed before film deposition, no process compatibility issues Implemented using thermal imprinting by Moritz, Landis, Nozières, Lebib, Chen, Diény, J. Appl. Phys., 91, 2002
- Also directly imprinted plastic substrates (no resist) imprinting provides surface finish

#### An Imprinting Process for Magnetic Patterning



### A stamp to Conform to Surface Roughness

- Maintain Bit Shape
- Long range order: 2nm over 1mm
- Conform to disk roughness and curvature





# Making a Stamp from a Master



### Imprinting a Replica



### **Imprinted Replica**

#### 30 nm high pillars





Diameter: 30 nm

Period: 50 nm

Height: 50 nm over 20 nm base



# Serpentine Test Pattern Imprint G. McClelland, C. Rettner, M.Hart •UV-Cured imprinted acrylate resist •100 nm wide lines and spaces, 50 nm high •200 lines over $(40 \ \mu m)^2$ field •No defects by SEM inspection (160,000 features) 5 µm

### Multiple Imprint Defect Rates

11th imprint from a single polymer stamp

60 nm pillars on 100 nm hexagonal array

about 7000 pillars shown

pillar-size defect rate 1-2/10,000

self-cleaning



### **Transferring Stamped Pattern**



### Magnetic Film Deposition and Characterization



## 300 Gb/in<sup>2</sup> Co/Pd Multilayers

#### Sputtered films on e-beam patterned pillars (S. Anders) AFM MFM



### Summary

 Patterning magnetic media can achieve high recording densities with low noise and high thermal stability

•This application is well-matched to the capabilities and limitations of imprinting.

•From an e-beam master, an almost unlimited number of flexible stamps can be formed.

• The flexible stamp accommodates surface roughness and curvature over the disk.

• Patterning pillars in the substrate provides magnetic patterning, eliminating processing after magnetic film deposition.